117397

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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chin-Hsiang Lin	04/16/2007
Chia-Jung Hsu	04/16/2007
Li-Wei Cheng	04/16/2007

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.	
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11739111

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	NAUP0822USA
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NAME OF SUBMITTER: WINSTON HSU

Total Attachments: 2

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PATENT REEL: 019197 FRAME: 0341

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):					
Name:	Chin-Hsiang Lin	Nationali	ty: R.O.C.			
Name:	Chia-Jung Hsu	Nationali	ty: R.O.C.			
Name:	Li-Wei Cheng	Nationali	ty: R.O.C.			
Hereby sells, as	ssigns and transfers to					
ASSIGNEE(S)	:					
Name:	UNITED MICROELECTRONICS CORP.					
Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.					
	sors and assignees of the ASS rovements which are disclosed		e, and interest in and to			
	OXIDE SEMICONDUCTOR TRATING METHOD THEREOF"	ANSISTOR WITH Y SHAPE	METAL GATE AND			
Which is foun	d in :					
(a) $+$	(a) U.S. patent application executed on even date					
(b)	(b) U.S. patent application executed on					
(c)	U.S. application serial no					
(d) p	patent no.	issued	 			

REEL: 019197 FRAME: 0342

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment,

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

APR 1 6 2007 IN WITNESS WHEREOF, We have hereunto set hand and seal this (Date of

(Type name of inventor)

Signing). (請發明人務必簽署上列日期。)

Signature of INVENTOR

Chin-Hsiang Lin

Chia-Jung Hsu

Li-Wei Cheng

Assignment, Page 2 of 2

F#NPO-P0002E-US1

NPO#NAU-P0822-USA:0 CUST#UMCD-2005-0705

RECORDED: 04/24/2007

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